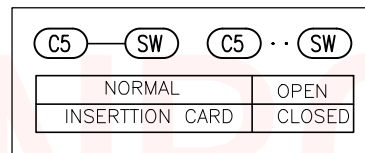
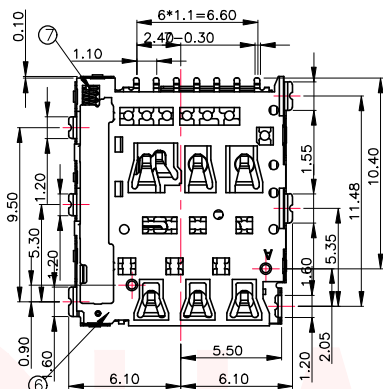
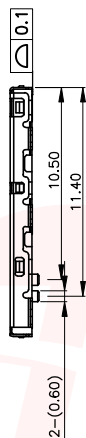
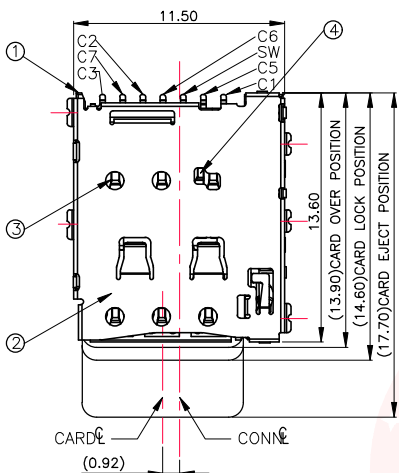
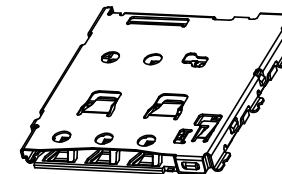


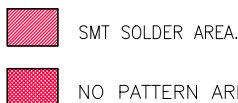
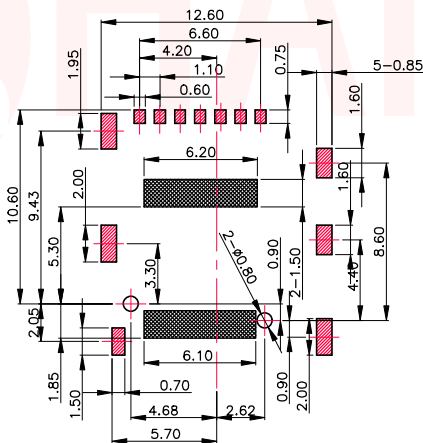
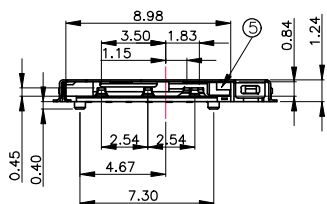


REV.	ECN NO OR DESCRIPTION	REVISED	DATE



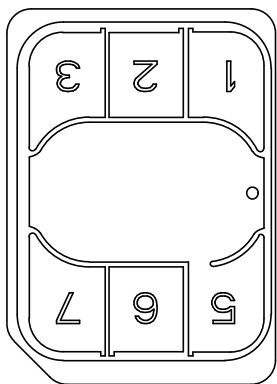
NOTES:

- FINISH:
 - CONTACT:
 - 50u"MIN NICKEL UNDER PLATED, 1u"MIN GOLD PLATING ON CONTACT AREA, GOLD FLASH PLATING ON SOLDERING AREA
 - SHELL:
 - 30u"MIN NICKEL UNDER PLATED;
 - 1u"MIN GOLD PLATING ON SOLDERING AREA.
- ELECTRICAL REQUIREMENTS:
 - RATED CURRENT: 0.5A
 - CONTACT RESISTANCE: 50mΩ MAX
 - INSULATION RESISTANCE: 1000Ω MIN 200V DC FOR 1 MINUTE
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.
- MECHANICAL REQUIREMENTS:
 - DURABILITY: 3000 CYCLES MIN.
- ENVIRONMENTAL REQUIREMENTS:
 - OPERATING TEMP: -30°C~+85°C
 - STORAGE TEMP: -40°C~+85°C
- RECOMMENDED PROCESS CONDITION:
 - IR-REFLOW, PEAK TEMPERATURE AND TIME: 250°C, 5-10S
- METAL MASK THICKNESS 0.10MM MIN



Nano SIM Circuit Description:

PIN No.	FUNCTION
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



RECOMMENDED PCB LAYOUT ALL TOLERANCE ±0.05MM

NO.	DESCRIPTION	Q'TY	Material
7	SPRING	1	THERMOPLASTIC RATING UL94V-0
6	LINK	1	STAINLESS STEEL
5	SLIDE	1	STAINLESS STEEL
4	DETECT PIN	1	COPPER ALLOY
3	CONTACT	1	COPPER ALLOY
2	SHELL	1	STAINLESS STEEL
1	HOUSING	1	LCP UL94V-0

UNLESS OTHERWISE SPECIFIED TOLERANCES



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

DECIMALS: X ±0.30 X.X ±0.20 X.XX ±0.10
 ANGLES: X ±2° X.X ±1°

TITLE	1.24 NANO SIM PUSH CONN CUSTOMER		
DWN	xiong	PART NO. SNO-1420	
CHKD	lee	SCALE: 1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET: 1 OF 1
			REV: A4

CUSTOMER COPY

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[H1.37](#) [MICRO SIM 7P H1.35](#) [TF-CARD H1.8 SY](#) [MICRO SIM 6P H1.35](#) [TF-CARD H1.8](#) [TF-115Y-BCP9](#) [TF-115YY-ACP9](#) [SMN-309-](#)
[ARP6](#) [TF-115Y-ACP9](#) [TF-108-ARP10](#) [SMN-303S-ACP7](#) [SNO-14100](#) [SD-112S](#) [MUP-C7804-1](#) [KH-TF-07DT](#)